



GR 99 P 5374

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By: Manfred Beck

Date: April 16, 2001

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Nicolas Nagel et al.
Applic. No. : 09/729,069
Filed : December 4, 2000
Title : Microelectronic Structure and Method of
Fabricating it

P R E L I M I N A R Y A M E N D M E N T

Hon. Commissioner of Patents and Trademarks,
Washington, D. C. 20231

S i r :

Responsive to the Notice to File Missing Parts dated February
20, 2001 kindly amend the above-identified application as
follows:

In the Specification:

Please replace the paragraph on page 20, lines 12-14 with the
following paragraph.